

Special Issue

Emerging Wearable Wireless Devices

Message from the Guest Editors

Due to growing interest in the use of technology in daily life, the potential of using wearable wireless devices across multiple segments, e.g., healthcare, sports, child monitoring, military, emergency, and consumer electronics, is rapidly increasing. It is predicted that there will be multibillion wearable sensors by 2025, with over 30% of them being new types of sensors that are just beginning to emerge. This Special Issue will focus on wireless wearable and implantable systems, flexible textile-based electronics, bio-electromagnetics, antennas and propagation, RF circuits, sensor, security of wearables and implantable systems, nano-bio communication, and electromagnetic sensing. Dr.

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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